

Vishay Siliconix

N-Channel 30-V (D-S) MOSFETs

PRODUCT SUMMARY						
	$V_{DS}(V)$	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
Channel-1	30	0.0240 at V _{GS} = 10 V	12 ^a	3.8 nC		
Channel-1	30	0.0300 at V_{GS} = 4.5 V	12 ^a	3.0 110		
Channel-2	30	0.0135 at V_{GS} = 10 V	16 ^a	7.3 nC		
Channel-2	-2 30	0.0170 at V_{GS} = 4.5 V	16 ^a	7.5110		

PowerPAIR[®] 6 x 3.7 Pin 1 C_{1} C_{2} C_{2}

Ordering Information:

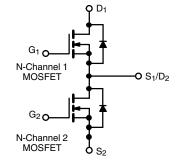
SiZ704DT-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook System Power
- POL
- Low Current DC/DC



Parameter	Symbol	Channel-1	Channel-2	Unit		
Drain-Source Voltage		V _{DS}	30	30	V	
Gate-Source Voltage		V _{GS}	± 20		V	
	T _C = 25 °C		12 ^a	16 ^a		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		12 ^a	16 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	Ι _D	9.4 ^{b, c}	14 ^{b, c}		
	T _A = 70 °C		7.5 ^{b, c}	11.2 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	30	40	А	
Course Drain Current Diado Current	T _C = 25 °C	1	12 ^a	16 ^a		
Source Drain Current Diode Current	T _A = 25 °C	۱ _S	3.1 ^{b, c}	3.7 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	10	15		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	5	11	mJ	
	T _C = 25 °C		20	30		
Maximum Dawar Dissinction	T _C = 70 °C		12.9	19	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.7 ^{b, c}	4.5 ^{b, c}	vv	
	T _A = 70 °C		2.4 ^{b, c}	2.9 ^{b, c}	1	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to 150		°C		
Soldering Recommendations (Peak Temperature) ^{d,}	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	26	60	Ĵ		

THERMAL RESISTANCE RATINGS							
Parameter Symbol Channel-1 Channel-2		Unit					
Falameter	Symbol		Тур.	Max.	Тур.	Max.	Onit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	26	34	21	28	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.7	6.2	3.2	4.2	0/11

Notes: a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 72 °C/W for Channel-1 and 67 °C/W for Channel-2.

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HALOGEN

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Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static					1			
		$V_{GS} = 0 V, I_D = 250 \mu A$ Ch-1		30				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	Ch-2	30			v	
		I _D = 250 μA	Ch-1		35			
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	Ch-2		33			
V Temperature Ocefficient		I _D = 250 μA	Ch-1		- 4.5		- mV/°C	
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	Ch-2		- 5			
Oata Thuashald Maltana	V	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	Ch-1	1		2.5		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	Ch-2	1.2		2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			± 100	nΔ	
Gale-Dody Leakage	GSS		Ch-2			± 100		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-2			1	μΑ	
Zero dale volage Diali ourient	.022	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C	Ch-1			5		
		V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C	Ch-2			5		
	1	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	Ch-1	20				
On-State Drain Current ^b	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-2	20			V mV/°C V nA	
		V _{GS} = 10 V, I _D = 7.8 A	Ch-1		0.0200	0.0240	- V mV/°C - NA - μA - A - A - A - A - A - S - S	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A	Ch-2		0.0105	0.0135		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	Ch-1		0.0240	0.0300	Ω	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	Ch-2		0.0135	0.0170		
b	~	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 7.8 \text{ A}$			17		_	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 10 V, I _D = 10 A	Ch-2		24		S	
Dynamic ^a	• • •		•		•		•	
Input Capacitance	C _{iss}		Ch-1		435			
input Capacitance	UISS	Channel-1	Ch-2		846			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz			95		nF	
	033	Channel-2	Ch-2		187			
Reverse Transfer Capacitance	C _{rss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	Ch-1		42			
			Ch-2		72	10		
		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.8 \text{ A}$	Ch-1		8			
Total Gate Charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 10 A	Ch-2		15.4	-	-	
		Channel-1	Ch-1		3.8	4 23 3 6		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 7.8 \text{ A}$	Ch-2		7.3	11	nC	
Gate-Source Charge	Q _{gs}		Ch-1 Ch-2		1.4 2.3		-	
		Channel-2	-		1.1		1	
Gate-Drain Charge	Drain Charge Q_{cd} $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ Ch-1					•		
	e-Drain Charge Q _{gd} Ch-2 2.2							
Gate Resistance	Rg	f = 1 MHz	Ch-1	0.6	3.2	6.4		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

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Parameter	Symbol		Min.	Тур.	Max.	Unit	
Dynamic ^a							
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-1		15	30	
	u(on)	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 2.4 \Omega$	Ch-2		15	30	
Rise Time	t _r	$I_D \cong 6.3 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_{\text{g}} = 1 \Omega$	Ch-1		12	24	
			Ch-2		12	24	-
Turn-Off Delay Time	t _{d(off)}	Channel-2	Ch-1 Ch-2		13	26	-
		VDD = 10 V, 11[= 1.0 S2			13 10	26 20	-
Fall Time	t _f	$I_{D} \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$	Ch-1 Ch-2		10	20	
			Ch-1		5	10	ns
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-2		9	18	
		V_{DD} = 15 V, R_L = 2.4 Ω	Ch-1		10	20	-
Rise Time	t _r	$\rm I_D \cong 6.3$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 1 Ω	Ch-2		9	18	
T 0"D T		Channel-2	Ch-1		15	30	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	Ch-2		14	28	
Fall Time	t _f	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$			10	20]
	Ч		Ch-2		8	16	
Drain-Source Body Diode Characteristic	s				1		1
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C	Ch-1			12	
	Ű		Ch-2			16	A
Pulse Diode Forward Current ^a	I _{SM}		Ch-1			30	-
		I _S = 6.3 A, V _{GS} = 0 V	Ch-2		0.0	40	
Body Diode Voltage	V_{SD}		Ch-1		0.8	1.2	v
		I _S = 3 A, V _{GS} = 0 V	Ch-2		0.78	1.2	
Body Diode Reverse Recovery Time	t _{rr}		Ch-1		15	30	ns
		Channel-1	Ch-2		17 7	34 15	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = 6.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	Ch-1 Ch-2		9.5	15	nC
			Ch-2		9.5	19	
Reverse Recovery Fall Time	t _a	Channel-2	Ch-2		10		-
		$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	Ch-1		6		ns
Reverse Recovery Rise Time	t _b		Ch-2		7		1

Notes:

a. Guaranteed by design, not subject to production testing.

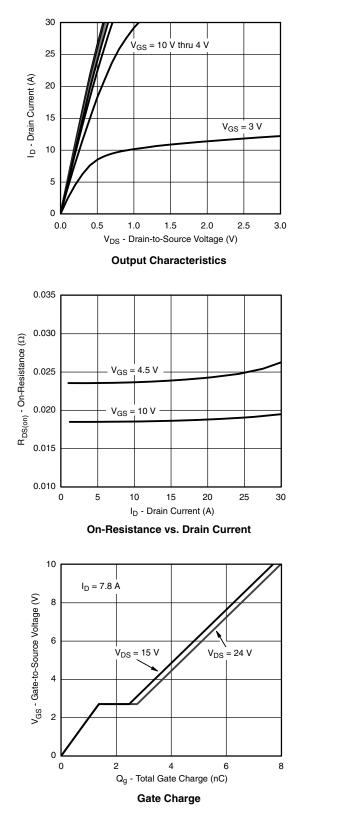
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

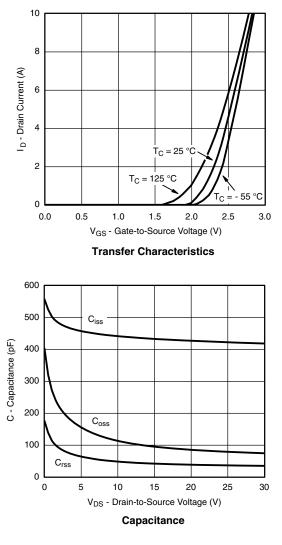
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

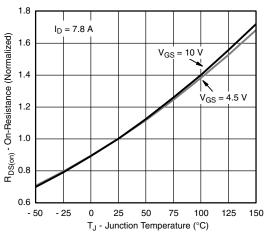


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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







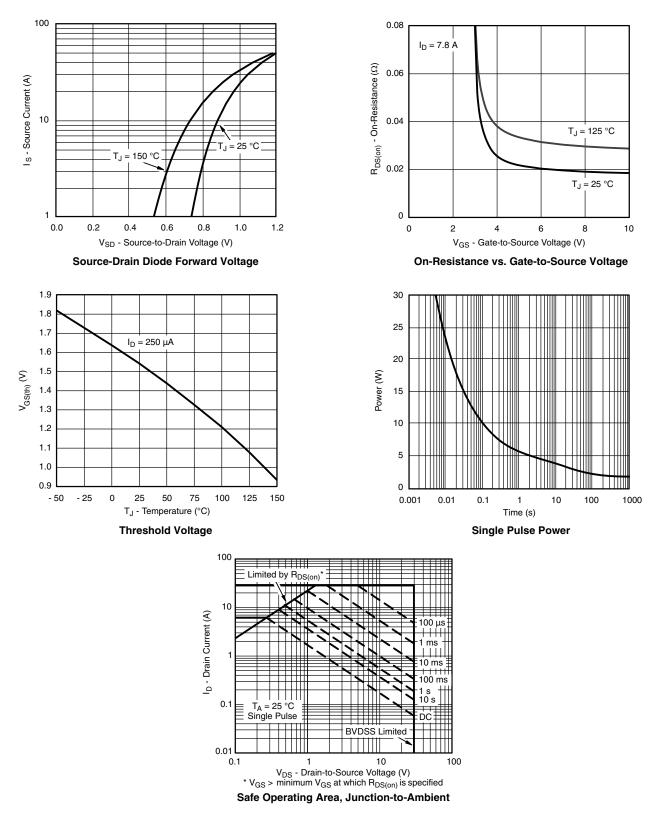
On-Resistance vs. Junction Temperature

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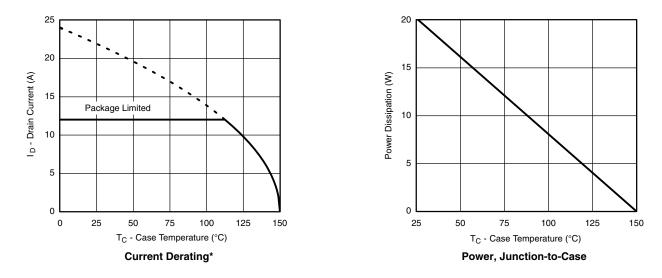
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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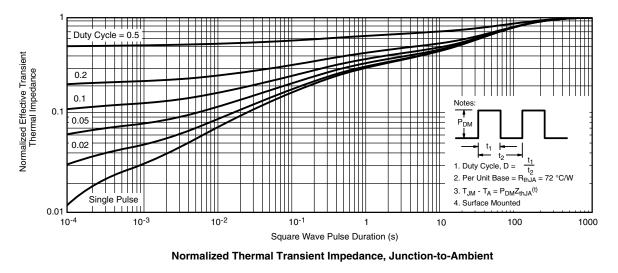


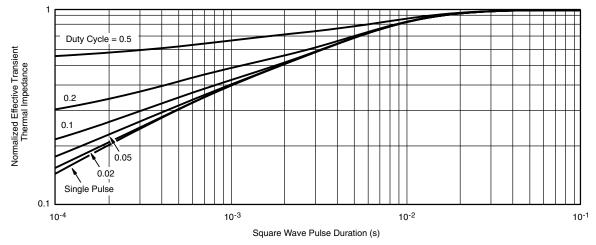
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



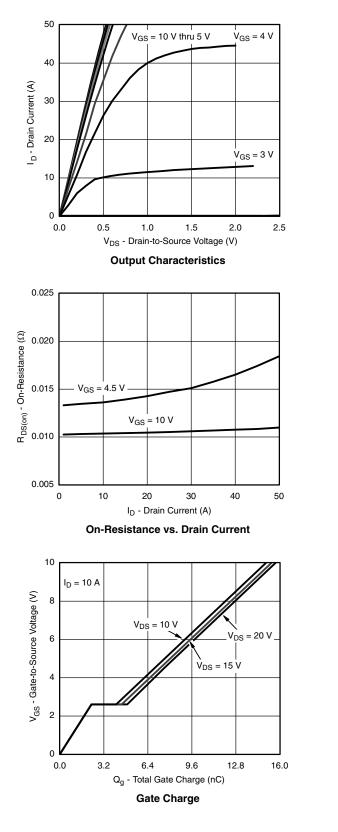


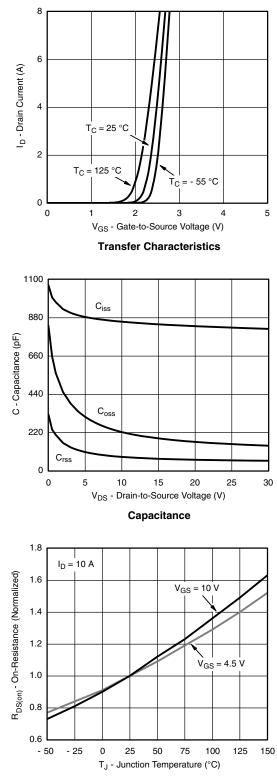
Normalized Thermal Transient Impedance, Junction-to-Case



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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature

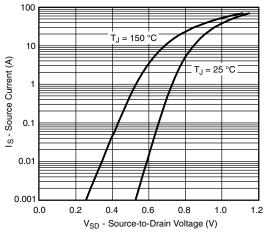
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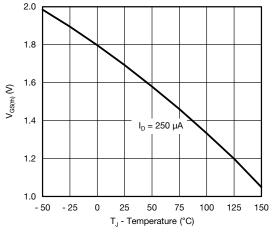


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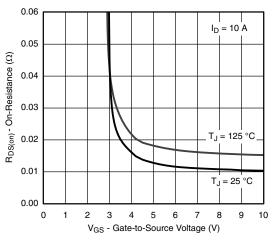
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



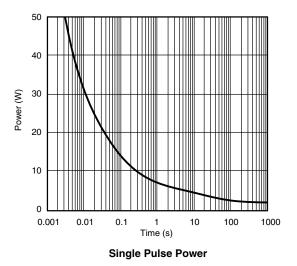
Source-Drain Diode Forward Voltage

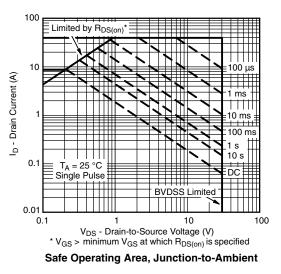






On-Resistance vs. Gate-to-Source Voltage

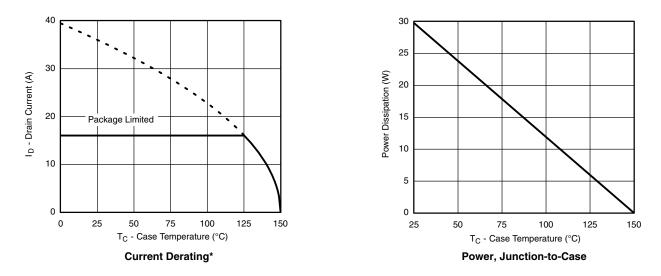




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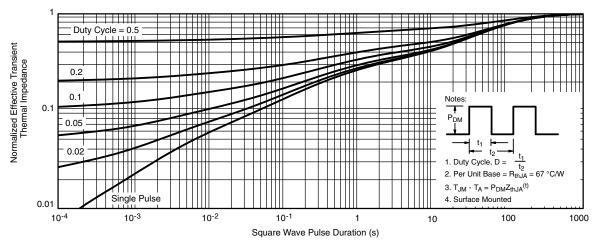
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

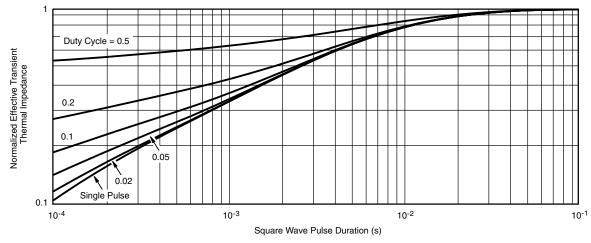


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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

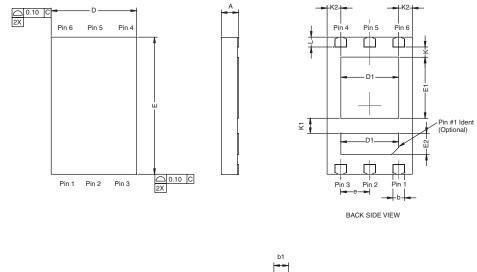


Normalized Thermal Transient Impedance, Junction-to-Case

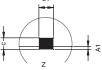
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PowerPAIR[™] 6 x 3.7 CASE OUTLINE





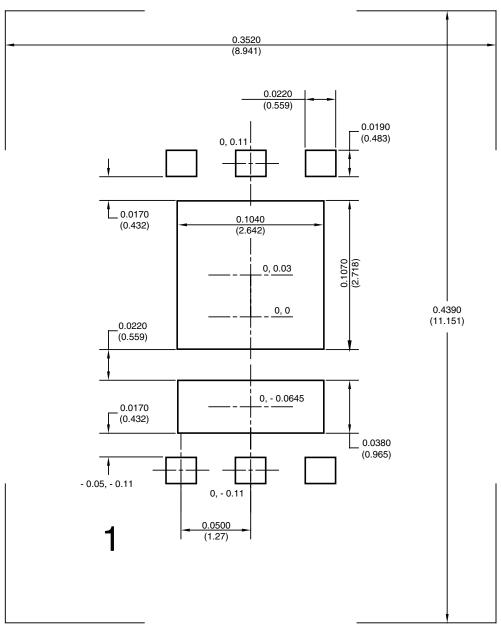


		MILLIMETERS		INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.70	0.75	0.80	0.028	0.030	0.032		
A1	0.00	-	0.05	0.000	-	0.002		
b	0.46	0.51	0.56	0.018	0.020	0.022		
b1	0.20	0.25	0.38	0.008	0.010	0.015		
С	0.18	0.20	0.23	0.007	0.008	0.009		
D	3.65	3.73	3.81	0.144	0.147	0.150		
D1	2.41	2.53	2.65	0.095	0.100	0.104		
E	5.92	6.00	6.08	0.233	0.236	0.239		
E1	2.62	2.67	2.72	0.103	0.105	0.107		
E2	0.87	0.92	0.97	0.034	0.036	0.038		
е		1.27 BSC			0.05 BSC			
К		0.45 TYP. 0.018 TYP.						
K1		0.66 TYP. 0.026 TYP.						
K2		0.60 TYP.			0.024 TYP.			
L	0.38	0.43	0.48	0.015	0.017	0.019		



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RECOMMENDED PAD FOR PowerPAIR™ 6 x 3.7



Recommended PAD for PowerPAIR 6 x 3.7 Dimensions in inches (mm) Keep-out 0.3520 (8.94) x 0.4390 (11.151)



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